# SN5410, SN54LS10, SN54S10, SN7410, SN74LS10, SN74S10 TRIPLE 3-INPUT POSITIVE-NAND GATES SDLS035A – DECEMBER 1983 – REVISED APRIL 2003

- Package Options Include Plastic "Small Outline" Packages, Ceramic Chip Carriers and Flat Packages, and Plastic and Ceramic DIPs
- Dependable Texas Instruments Quality and Reliability

#### description

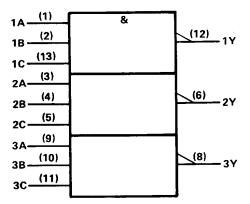
These devices contain three independent 3-input NAND gates.

The SN5410, SN54LS10, and SN54S10 are characterized for operation over the full military temperature range of -55 °C to 125 °C. The SN7410, SN74LS10, and SN74S10 are characterized for operation from 0 °C to 70 °C.

| FUNCTION TABLE | leach | gate) |
|----------------|-------|-------|
|----------------|-------|-------|

| 11 | VPUT | S        | OUTPUT |
|----|------|----------|--------|
| A  | В    | с        | Y      |
| н  | н    | н        | L      |
| L  | X    | x        | н      |
| x  | L    | <b>x</b> | н      |
| x  | х    | εl       | н      |

# logic symbol<sup>†</sup>



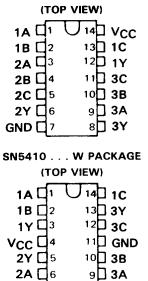
<sup>†</sup>This symbol is in accordance with ANSI/IEEE Std. 91-1984 and IEC Publication 617-12.

Pin numbers shown are for D, J, and N packages.

#### positive logic

$$Y = \overline{A \cdot B \cdot C}$$
 or  $Y = \overline{A} + \overline{B} + \overline{C}$ 

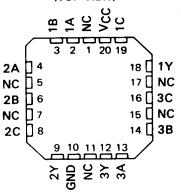
SN5410 . . . J PACKAGE SN54LS10, SN54S10 . . . J OR W PACKAGE SN7410 . . . N PACKAGE SN74LS10, SN74S10 . . . D OR N PACKAGE



SN54LS10, SN54S10 . . . FK PACKAGE (TOP VIEW)

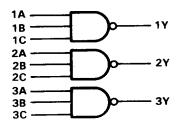
8 **2**C

2B 🗌



NC - No internal connection

### logic diagram (positive logic)



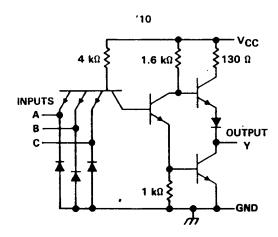
PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

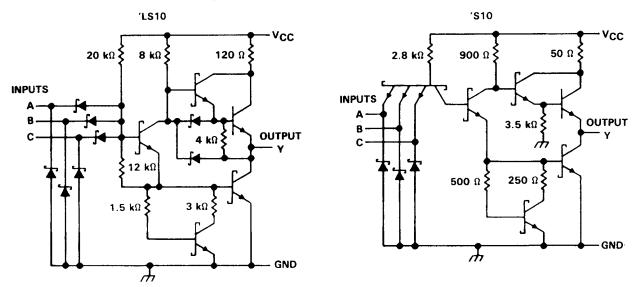


# SN5410, SN54LS10, SN54S10, SN7410, SN74LS10, SN74S10 TRIPLE 3-INPUT POSITIVE-NAND GATES SDLS035A - DECEMBER 1983 - REVISED APRIL 2003

SDLS035A – DECEMBER 1983 – REVISED API

# schematics (each gate)





Resistor values shown are nominal.

#### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

| Supply voltage, V <sub>CC</sub> (see Note 1) | 7V                |
|--|-------------------|
| Input voltage: '10, 'S10                     |                   |
| 'LS10  | <b>7</b> V        |
| Operating free-air temperature range: SN54'  | – 55 °C to 125 °C |
| SN74′  | 0°C to 70°C       |
| Storage temperature range                    | -65°C to 150°C    |

NOTE 1: Voltage values are with respect to network ground terminal.



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# recommended operating conditions

|                 |                                |      | SN5410 SN7410 |       |      |     |       |      |
|-----------------|--------------------------------|------|---------------|-------|------|-----|-------|------|
|                 |                                | MIN  | NOM           | MAX   | MIN  | NOM | MAX   | UNIT |
| Vcc             | Supply voltage                 | 4.5  | 5             | 5.5   | 4.75 | 5   | 5.25  | v    |
| VIH             | High-level input voltage       | 2    |               |       | 2    |     |       | v    |
| V <sub>IL</sub> | Low-level input voltage        |      |               | 0.8   |      |     | 0.8   | v    |
| юн              | High-level output current      |      |               | - 0.4 |      |     | - 0.4 | mA   |
| IOL             | Low-level output current       |      |               | 16    |      |     | 16    | mA   |
| TA              | Operating free-air temperature | - 55 |               | 125   | 0    |     | 70    | °c   |

# electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER | TEST CONDITIONS T   | SN5410     | SN7410         |    |
|-----------|---|------------|----------------|----|
|           |   | MIN TYP‡ M | X MIN TYPE MAX |    |
| VIK       | $V_{CC} = MIN, I_{I} = -12 \text{ mA}$                                | -          | .5 – 1.5       | V  |
| VOH       | $V_{CC}$ = MIN, $V_{1L}$ = 0.8 V, $I_{OH}$ = $-0.4$ m                 | A 2.4 3.4  | 2.4 3.4        | V  |
| VOL       | V <sub>CC</sub> = MIN, V <sub>IH</sub> = 2 V, I <sub>OL</sub> = 16 mA | 0.2 (      | 0.4 0.2 0.4    | V  |
| 1         | V <sub>CC</sub> = MAX, V <sub>I</sub> = 5.5 V                         |            | 1 1            | mA |
| Чн        | V <sub>CC</sub> = MAX, V <sub>I</sub> = 2.4 V                         |            | 40 40          | μA |
| 11L       | V <sub>CC</sub> = MAX, V <sub>I</sub> = 0.4 V                         | _ 1        | .6 – 1.6       | mA |
| IOS§      | V <sub>CC</sub> = MAX   | - 20 -     | 55 – 18 – 55   | mA |
| Іссн      | V <sub>CC</sub> = MAX, V <sub>1</sub> = 0 V                           | 3          | 6 3 6          | mA |
| ICCL      | V <sub>CC</sub> = MAX, V <sub>1</sub> = 4.5 V                         | 9 16       | .5 9 16.5      | mA |

† For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

<sup>‡</sup> All typical values are at  $V_{CC}$  = 5 V,  $T_A$  = 25°C.

§ Not more than one output should be shorted at a time.

# switching characteristics, $V_{CC} = 5 V$ , $T_A = 25^{\circ}C$ (see note 2)

| PARAMETER        | FROM      | то       |  |     |     |     |      |
|------------------|-----------|----------|--|-----|-----|-----|------|
|                  | (INPUT)   | (OUTPUT) | TEST CONDITIONS                            | MIN | ТҮР | MAX | UNIT |
| <sup>t</sup> PLH | A, B or C | · ·      |  |     | 11  | 22  | ns   |
| <sup>t</sup> PHL |           | Ť        | $R_{L} = 400 \Omega, \qquad C_{L} = 15 pF$ |     | 7   | 15  | ns   |

NOTE 2: Load circuits and voltage waveforms are shown in Section 1.



# SN54LS10, SN74LS10, TRIPLE 3-INPUT POSITIVE-NAND GATES

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#### recommended operating conditions

|   | SN54LS10 |     |       | •    | UNIT  |       |      |
|---|----------|-----|-------|------|-------|-------|------|
|   | <br>MIN  | NOM | MAX   | MIN  | NOM   | MAX   | UNII |
| V <sub>CC</sub> Supply voltage              | <br>4.5  | 5   | 5.5   | 4.75 | 5     | 5.25  | v    |
| VIH High-level input voltage                | 2        |     |       | 2    |       |       | v    |
| VIL Low-level input voltage                 |          |     | 0.7   |      |       | 0.8   | v    |
| IOH High-level output current               |          |     | - 0.4 |      | · · · | - 0.4 | mA   |
| IOL Low-level output current                |          |     | 4     |      |       | 8     | mA   |
| T <sub>A</sub> Operating free-air temperatu | - 55     |     | 125   | 0    |       | 70    | °c   |

# electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER       |                        | TEST CONDI               | rione t                  |      | SN54LS | 10    |      | SN74LS | 510 · |      |
|-----------------|------------------------|--------------------------|--------------------------|------|--------|-------|------|--------|-------|------|
| FARAMETER       |                        | TEST CONDIT              |                          | MIN  | TYP‡   | MAX   | MIN  | TYP‡   | MAX   | UNIT |
| VIK             | V <sub>CC</sub> = MIN, | l <sub>l</sub> = – 18 mA |                          |      |        | - 1.5 |      |        | - 1.5 | V    |
| V <sub>OH</sub> | V <sub>CC</sub> = MIN, | VIL = MAX,               | l <sub>OH</sub> = 0.4 mA | 2.5  | 3.4    |       | 2.7  | 3.4    |       | V    |
| N.c.            | V <sub>CC</sub> = MIN, | V <sub>IH</sub> = 2 V,   | 1 <sub>OL</sub> = 4 mA   |      | 0.25   | 0.4   | [    |        | 0.4   |      |
| VOL             | V <sub>CC</sub> = MIN, | V <sub>1H</sub> = 2 V,   | IOL = 8 mA               |      |        |       | 1    | 0.25   | 0.5   | -    |
| Ι <sub>Ι</sub>  | V <sub>CC</sub> = MAX, | V <sub>1</sub> = 7 V     |                          | 1    |        | 0.1   |      |        | 0.1   | mA   |
| ųн              | V <sub>CC</sub> = MAX, | V <sub>1</sub> = 2.7 V   |                          |      |        | 20    | 1    |        | 20    | μΑ   |
| ίιΓ             | V <sub>CC</sub> = MAX, | V1 = 0.4 V               |                          |      |        | - 0.4 |      |        | - 0.4 | mA   |
| los§            | V <sub>CC</sub> = MAX  |                          |                          | - 20 |        | - 100 | - 20 |        | - 100 | mA   |
| Іссн            | V <sub>CC</sub> = MAX, | V <sub>I</sub> = 0 V     |                          |      | 0.6    | 1.2   |      | 0.6    | 1.2   | mA   |
| ICCL            | V <sub>CC</sub> = MAX, | V <sub>1</sub> = 4.5 V   |                          |      | 1.8    | 3.3   |      | 1.8    | 3.3   | mA   |

† For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

‡ All typical values are at  $V_{CC} = 5 V$ ,  $T_A = 25^{\circ}C$ . § Not more than one output should be shorted at a time, and the duration of the short-circuit should not exceed one second.

# switching characteristics, $V_{CC} = 5 V$ , $T_A = 25^{\circ}C$ (see note 2)

| PARAMETER        | FROM<br>(INPUT) | TO<br>(OUTPUT) | TEST CON             | MIN                    | түр | мах | UNIT |    |
|------------------|-----------------|----------------|----------------------|------------------------|-----|-----|------|----|
| tPLH             | A, B or C       | Y              | $R_1 = 2 k \Omega_2$ | C: = 15 pE             |     | 9   | 15   | ns |
| <sup>t</sup> PHL |                 | •              | AL - 2 KS2,          | С <sub>L</sub> = 15 рF |     | 10  | 15   | ns |

NOTE 2: Load circuits and voltage waveforms are shown in Section 1.



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### recommended operating conditions

|                 |                                |      | SN54S10 SN74S10 |     |      | 10  | UNIT |      |
|-----------------|--------------------------------|------|-----------------|-----|------|-----|------|------|
|                 |                                | MIN  | NOM             | MAX | MIN  | NOM | MAX  | UNIT |
| vcc             | Supply voltage                 | 4.5  | 5               | 5.5 | 4.75 | 5   | 5.25 | v    |
| v <sub>IH</sub> | High-level input voltage       | 2    |                 |     | 2    |     |      | v    |
| VIL             | Low-level input voltage        |      |                 | 0.8 |      |     | 0.8  | v    |
| юн              | High-level output current      |      |                 | - 1 |      |     | - 1  | mA   |
| IOL             | Low-level output current       |      |                 | 20  | 1    |     | 20   | mA   |
| TA              | Operating free-air temperature | - 55 |                 | 125 | 0    |     | 70   | °C   |

### electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

|                  |  | SN54S10      | SN74S10      |      |
|------------------|--|--------------|--------------|------|
| PARAMETER        | TEST CONDITIONS †  | MIN TYP‡ MAX | MIN TYP‡ MAX | UNIT |
| VIK              | V <sub>CC</sub> = MIN, I <sub>I</sub> = -18 mA             | -1.2         | -1.2         | v    |
| V <sub>OH</sub>  | $V_{CC} \approx MIN$ , $V_{IL} = 0.8 V$ , $I_{OH} = -1 mA$ | 2,5 3,4      | 2.7 3.4      | v    |
| VOL              | $V_{CC} = MIN, V_{IH} = 2 V, I_{OL} = 20 mA$               | 0.5          | 0.5          | v    |
| lj               | V <sub>CC</sub> = MAX, V <sub>I</sub> = 5.5 V              | 1            | 1            | mA   |
| ін               | V <sub>CC</sub> = MAX, V <sub>I</sub> = 2.7 V              | 50           | 50           | μA   |
| ŧι∟              | V <sub>CC</sub> = MAX, V <sub>I</sub> = 0.5 V              | -2           | -2           | mA   |
| IOS §            | V <sub>CC</sub> = MAX                                      | -40 -100     | -40 -100     | mA   |
| <sup>I</sup> ССН | V <sub>CC</sub> = MAX, V <sub>I</sub> = 0 V                | 7.5 12       | 7.5 12       | mA   |
| ICCL             | V <sub>CC</sub> = MAX, V <sub>I</sub> = 4.5 V              | 15 27        | 15 27        | mA   |

† For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

‡ All typical values are at  $V_{CC} = 5 V$ ,  $T_A = 25^{\circ}C$ . § Not more than one output should be shorted at a time, and the duration of the short-circuit should not exceed one second.

#### то FROM PARAMETER **TEST CONDITIONS** MIN ТҮР MAX UNIT (INPUT) (OUTPUT) 3 4.5 **tPLH** ns $R_L = 280 \Omega$ , C<sub>L</sub> = 15 pF TPHL 3 5 ns A, B or C Y 4.5 <sup>t</sup>PLH ns $R_L = 280 \Omega$ , CL = 50 pF 5 <sup>t</sup>PHL ns

# switching characteristics, $V_{CC} = 5 V$ , $T_A = 25^{\circ}C$ (see note 2)

NOTE 2: Load circuits and voltage waveforms are shown in Section 1.





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# **PACKAGING INFORMATION**

| Orderable Device | Status   | Package Type | •       | Pins | •   | Eco Plan | Lead/Ball Finish | MSL Peak Temp      | Op Temp (°C) | Device Marking       | Samples |
|------------------|----------|--------------|---------|------|-----|----------|------------------|--------------------|--------------|----------------------|---------|
|                  | (1)      |              | Drawing |      | Qty | (2)      | (6)              | (3)                |              | (4/5)                |         |
| JM38510/00103BCA | OBSOLETE | CDIP         | J       | 14   |     | TBD      | Call TI          | Call TI            | -55 to 125   |                      |         |
| JM38510/00103BDA | OBSOLETE | CFP          | W       | 14   |     | TBD      | Call TI          | Call TI            | -55 to 125   |                      |         |
| JM38510/07005BCA | ACTIVE   | CDIP         | J       | 14   | 1   | TBD      | A42              | N / A for Pkg Type | -55 to 125   | JM38510/<br>07005BCA | Samples |
| JM38510/07005BDA | ACTIVE   | CFP          | W       | 14   | 1   | TBD      | A42              | N / A for Pkg Type | -55 to 125   | JM38510/<br>07005BDA | Samples |
| JM38510/30005B2A | ACTIVE   | LCCC         | FK      | 20   | 1   | TBD      | POST-PLATE       | N / A for Pkg Type | -55 to 125   | JM38510/<br>30005B2A | Samples |
| JM38510/30005BCA | ACTIVE   | CDIP         | J       | 14   | 1   | TBD      | A42              | N / A for Pkg Type | -55 to 125   | JM38510/<br>30005BCA | Samples |
| JM38510/30005BDA | ACTIVE   | CFP          | W       | 14   | 1   | TBD      | A42              | N / A for Pkg Type | -55 to 125   | JM38510/<br>30005BDA | Samples |
| JM38510/30005SDA | ACTIVE   | CFP          | W       | 14   | 25  | TBD      | A42              | N / A for Pkg Type | -55 to 125   | JM38510/<br>30005SDA | Samples |
| M38510/07005BCA  | ACTIVE   | CDIP         | J       | 14   | 1   | TBD      | A42              | N / A for Pkg Type | -55 to 125   | JM38510/<br>07005BCA | Samples |
| M38510/07005BDA  | ACTIVE   | CFP          | W       | 14   | 1   | TBD      | A42              | N / A for Pkg Type | -55 to 125   | JM38510/<br>07005BDA | Samples |
| M38510/30005B2A  | ACTIVE   | LCCC         | FK      | 20   | 1   | TBD      | POST-PLATE       | N / A for Pkg Type | -55 to 125   | JM38510/<br>30005B2A | Samples |
| M38510/30005BCA  | ACTIVE   | CDIP         | J       | 14   | 1   | TBD      | A42              | N / A for Pkg Type | -55 to 125   | JM38510/<br>30005BCA | Samples |
| M38510/30005BDA  | ACTIVE   | CFP          | W       | 14   | 1   | TBD      | A42              | N / A for Pkg Type | -55 to 125   | JM38510/<br>30005BDA | Samples |
| M38510/30005SDA  | ACTIVE   | CFP          | W       | 14   | 25  | TBD      | A42              | N / A for Pkg Type | -55 to 125   | JM38510/<br>30005SDA | Samples |
| SN5410J          | OBSOLETE | CDIP         | J       | 14   |     | TBD      | Call TI          | Call TI            | -55 to 125   |                      |         |
| SN54LS10J        | ACTIVE   | CDIP         | J       | 14   | 1   | TBD      | A42              | N / A for Pkg Type | -55 to 125   | SN54LS10J            | Samples |
| SN54S10J         | ACTIVE   | CDIP         | J       | 14   | 1   | TBD      | A42              | N / A for Pkg Type | -55 to 125   | SN54S10J             | Samples |
| SN7410N          | OBSOLETE | PDIP         | Ν       | 14   |     | TBD      | Call TI          | Call TI            | 0 to 70      | SN7410N              |         |
| SN7410N3         | OBSOLETE | E PDIP       | Ν       | 14   |     | TBD      | Call TI          | Call TI            | 0 to 70      |                      |         |



# PACKAGE OPTION ADDENDUM

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| Orderable Device | Status   | Package Type | Package | Pins | Package | Eco Plan                   | Lead/Ball Finish | MSL Peak Temp      | Op Temp (°C) | Device Marking  | Samples |
|------------------|----------|--------------|---------|------|---------|----------------------------|------------------|--------------------|--------------|-----------------|---------|
|                  | (1)      |              | Drawing |      | Qty     | (2)                        | (6)              | (3)                |              | (4/5)           |         |
| SN74LS10D        | ACTIVE   | SOIC         | D       | 14   | 50      | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM | 0 to 70      | LS10            | Samples |
| SN74LS10DG4      | ACTIVE   | SOIC         | D       | 14   | 50      | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM | 0 to 70      | LS10            | Samples |
| SN74LS10DR       | ACTIVE   | SOIC         | D       | 14   | 2500    | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM | 0 to 70      | LS10            | Samples |
| SN74LS10DRE4     | ACTIVE   | SOIC         | D       | 14   | 2500    | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM | 0 to 70      | LS10            | Samples |
| SN74LS10DRG4     | ACTIVE   | SOIC         | D       | 14   | 2500    | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM | 0 to 70      | LS10            | Samples |
| SN74LS10N        | ACTIVE   | PDIP         | Ν       | 14   | 25      | Pb-Free<br>(RoHS)          | CU NIPDAU        | N / A for Pkg Type | 0 to 70      | SN74LS10N       | Samples |
| SN74LS10N3       | OBSOLETE | PDIP         | N       | 14   |         | TBD                        | Call TI          | Call TI            | 0 to 70      |                 |         |
| SN74LS10NSR      | ACTIVE   | SO           | NS      | 14   | 2000    | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM | 0 to 70      | 74LS10          | Samples |
| SN74S10N         | ACTIVE   | PDIP         | N       | 14   | 25      | Pb-Free<br>(RoHS)          | CU NIPDAU        | N / A for Pkg Type | 0 to 70      | SN74S10N        | Samples |
| SN74S10N3        | OBSOLETE | PDIP         | Ν       | 14   |         | TBD                        | Call TI          | Call TI            | 0 to 70      |                 |         |
| SNJ5410J         | OBSOLETE | CDIP         | J       | 14   |         | TBD                        | Call TI          | Call TI            | -55 to 125   |                 |         |
| SNJ5410W         | OBSOLETE | CFP          | W       | 14   |         | TBD                        | Call TI          | Call TI            | -55 to 125   |                 |         |
| SNJ5410WA        | OBSOLETE | E CFP        | WA      | 14   |         | TBD                        | Call TI          | Call TI            | -55 to 125   |                 |         |
| SNJ54LS10FK      | ACTIVE   | LCCC         | FK      | 20   | 1       | TBD                        | POST-PLATE       | N / A for Pkg Type | -55 to 125   | SNJ54LS<br>10FK | Samples |
| SNJ54LS10J       | ACTIVE   | CDIP         | J       | 14   | 1       | TBD                        | A42              | N / A for Pkg Type | -55 to 125   | SNJ54LS10J      | Samples |
| SNJ54LS10W       | ACTIVE   | CFP          | W       | 14   | 1       | TBD                        | A42              | N / A for Pkg Type | -55 to 125   | SNJ54LS10W      | Samples |
| SNJ54S10J        | ACTIVE   | CDIP         | J       | 14   | 1       | TBD                        | A42              | N / A for Pkg Type | -55 to 125   | SNJ54S10J       | Samples |
| SNJ54S10W        | ACTIVE   | CFP          | W       | 14   | 1       | TBD                        | A42              | N / A for Pkg Type | -55 to 125   | SNJ54S10W       | Samples |

<sup>(1)</sup> The marketing status values are defined as follows: **ACTIVE:** Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.



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(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

**TBD:** The Pb-Free/Green conversion plan has not been defined.

**Pb-Free (RoHS):** TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes. **Pb-Free (RoHS Exempt):** This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

<sup>(3)</sup> MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

<sup>(4)</sup> There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(<sup>5)</sup> Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

<sup>(6)</sup> Lead/Ball Finish - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

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#### OTHER QUALIFIED VERSIONS OF SN5410, SN54LS10, SN54LS10-SP, SN54S10, SN7410, SN74LS10, SN74S10 :

• Catalog: SN7410, SN74LS10, SN54LS10, SN74S10

• Military: SN5410, SN54LS10, SN54S10

Space: SN54LS10-SP

NOTE: Qualified Version Definitions:

# PACKAGE OPTION ADDENDUM



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17-Dec-2015

- Catalog TI's standard catalog product
- Military QML certified for Military and Defense Applications
- Space Radiation tolerant, ceramic packaging and qualified for use in Space-based application

# PACKAGE MATERIALS INFORMATION

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# TAPE AND REEL INFORMATION

# REEL DIMENSIONS

Texas Instruments





TAPE AND REEL INFORMATION

#### TAPE DIMENSIONS



| A0 | Dimension designed to accommodate the component width     |
|----|---|
| B0 | Dimension designed to accommodate the component length    |
| K0 | Dimension designed to accommodate the component thickness |
| W  | Overall width of the carrier tape                         |
| P1 | Pitch between successive cavity centers                   |

| *All dimensions are nominal |                 |                    |    |      |                          |                          |            |            |            |            |           |                  |
|-----------------------------|-----------------|--------------------|----|------|--------------------------|--------------------------|------------|------------|------------|------------|-----------|------------------|
| Device                      | Package<br>Type | Package<br>Drawing |    | SPQ  | Reel<br>Diameter<br>(mm) | Reel<br>Width<br>W1 (mm) | A0<br>(mm) | B0<br>(mm) | K0<br>(mm) | P1<br>(mm) | W<br>(mm) | Pin1<br>Quadrant |
| SN74LS10DR                  | SOIC            | D                  | 14 | 2500 | 330.0                    | 16.4                     | 6.5        | 9.0        | 2.1        | 8.0        | 16.0      | Q1               |
| SN74LS10NSR                 | SO              | NS                 | 14 | 2000 | 330.0                    | 16.4                     | 8.2        | 10.5       | 2.5        | 12.0       | 16.0      | Q1               |

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# PACKAGE MATERIALS INFORMATION

14-Jul-2012



\*All dimensions are nominal

| Device      | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|-------------|--------------|-----------------|------|------|-------------|------------|-------------|
| SN74LS10DR  | SOIC         | D               | 14   | 2500 | 367.0       | 367.0      | 38.0        |
| SN74LS10NSR | SO           | NS              | 14   | 2000 | 367.0       | 367.0      | 38.0        |

J (R-GDIP-T\*\*) 14 LEADS SHOWN

CERAMIC DUAL IN-LINE PACKAGE



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- C. This package is hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
- E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

W (R-GDFP-F14)

CERAMIC DUAL FLATPACK



- NOTES: A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
  - C. This package can be hermetically sealed with a ceramic lid using glass frit.
  - D. Index point is provided on cap for terminal identification only.
  - E. Falls within MIL STD 1835 GDFP1-F14



LEADLESS CERAMIC CHIP CARRIER

FK (S-CQCC-N\*\*) 28 TERMINAL SHOWN



NOTES: A. All linear dimensions are in inches (millimeters).

B. This drawing is subject to change without notice.

C. This package can be hermetically sealed with a metal lid.

D. Falls within JEDEC MS-004



# N (R-PDIP-T\*\*)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



NOTES:

- A. All linear dimensions are in inches (millimeters).B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- $\triangle$  The 20 pin end lead shoulder width is a vendor option, either half or full width.



D (R-PDSO-G14)

PLASTIC SMALL OUTLINE



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
- Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
- E. Reference JEDEC MS-012 variation AB.





NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Publication IPC-7351 is recommended for alternate designs.
- D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
  E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.



# MECHANICAL DATA

# PLASTIC SMALL-OUTLINE PACKAGE

#### 0,51 0,35 ⊕0,25⊛ 1,27 8 14 0,15 NOM 5,60 8,20 5,00 7,40 $\bigcirc$ Gage Plane ₽ 0,25 7 1 1,05 0,55 0-10 Δ 0,15 0,05 Seating Plane — 2,00 MAX 0,10PINS \*\* 14 16 20 24 DIM 10,50 10,50 12,90 15,30 A MAX A MIN 9,90 9,90 12,30 14,70 4040062/C 03/03

NOTES: A. All linear dimensions are in millimeters.

NS (R-PDSO-G\*\*)

**14-PINS SHOWN** 

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



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